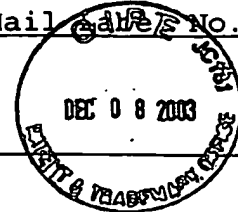


INFORMATION  
DISCLOSURE  
CITATION

Applicant: Simon FENNEY, et al  
 Ser.No. : 10/611 719 Filed : July 1, 2003  
 Conf. No.: 6086 Atty.Ref.: R&G 359  
 Group : 2673



## U.S. PATENT DOCUMENTS

Examiner Initial*	Document Number	Date	Name	Class	Sub Class	Filing Date
Ac.	AA	5 949 424	Sep 1999	Cabral, et al	—	—
	AB					
	AC					
	AD					
	AE					
	AF					

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Ac.	AX	U.S. Patent Application No. 10/621,111 filed July 2003

EXAMINER

*Ante Cole*

DATE CONSIDERED

3/8/04

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to Applicant.